IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIE	Material Compos © Copyright 2005. IPC international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowelevel parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Form Typ Distribute				e * Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information				
Supplier Inforn	nation															
Company name* Company				ompany unique ID			Unique ID Authority					Respons	Response Date*			
onsemi												2024-05-	2024-05-09			
Contact Name		Title - Contact			P	Phone - Contact*					Email -	Email - Contact*				
Product-Env-Stewa	ards	Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com					
uthorized Represe	entative*	Title - Representative			P	Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
Request	ester Item Number Mfr Item		m Number Mfr Item Name				Effective Date Version		rsion	Manufacturing Site PH1		1	Weigh	t*	UOM	Unit Type
				NCP1618L (mult NCP1618)	CP1618L (multi mode) PFC (metal tweak CP1618)		2024-05-09 PI		7			74.52 mg		mg	Each	
Ianufacturing	Process Information	on														
Terminal	Plating / Grid Array Material		erminal Base Alloy J-STI		J-STD-020 MSL R	ISL Rating Pe		k Process Body Temperature		re Max	Time at Peal	k Temperat	ure]	Number	of Reflow Cyc	les
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 1		1		260		С		30 seco		ds .	3		
Comments					·	·	· ·	•	· ·					•		
evel 1 - maximum	time at peak temperatur	e during sol	ldering is 10-3	0 seconds					<u> </u>							
or more informati	on regarding material co	omposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a		
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per t	he definition above except for defined Rol	IS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.26	mg	Supplier	Silicon (Si)	7440-21-3		1.26	mg
Die Attach Epoxy	0.37	mg	Supplier	Silver (Ag)	7440-22-4		0.3145	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.0555	mg
Lead Frame	21.32	mg	Supplier	Zinc (Zn)	7440-66-6		0.0256	mg
			Supplier	Iron (Fe)	7439-89-6		0.501	mg
			Supplier	Copper (Cu)	7440-50-8		20.787	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0064	mg
Mold Compound-Black	50.28	mg		Epoxy resin	proprietary data		2.514	mg
			Supplier	Phenolic Resin	Proprietary Data		1.0056	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.257	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2514	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		45.252	mg
Plating	1.14	mg	Supplier	Palladium (Pd)	7440-05-3		0.0798	mg
			В	Nickel (Ni)	7440-02-0		1.0374	mg
			Supplier	Gold (Au)	7440-57-5		0.0228	mg
Wire Bond - Au	0.15	mg	Supplier	Gold (Au)	7440-57-5		0.15	mg